Am26S10/Am26S11

Quad Bus Transceivers

DISTINCTIVE CHARACTERISTICS

- Input to bus is inverting on Am26S10
- Input to bus is non-inverting on Am26S11
- Quad high-speed open collector bus transceivers
- Driver outputs can sink 100mA at 0.8V maximum
- Bus compatible with Am2905, Am2906. Am2907
- Advanced Schottky processing
- PNP inputs to reduce input loading

GENERAL DESCRIPTION

The Am26S10 and Am26S11 are quad Bus Transceivers consisting of four high-speed bus drivers with open-collector outputs capable of sinking 100mA at 0.8 volts and four high-speed bus receivers. Each driver output is connected internally to the high-speed bus receiver in addition to being connected to the package pin. The receiver has a Schottky TTL output capable of driving ten Schottky TTL unit loads.

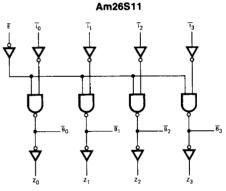
An active LOW enable gate controls the four drivers so that outputs of different device drivers can be connected together for party-line operation. The enable input can be conveniently driven by active LOW decoders such as the Am25LS139.

The bus output high-drive capability in the LOW state allows party-line operation with a line impedance as low as 100Ω . The line can be terminated at both ends, and still give considerable noise margin at the receiver. The receiver typical switching point is 2.0 volts.

The Am26S10 and Am26S11 feature advanced Schottky processing to minimize propagation delay. The device package also has two ground pins to improve ground current handling and allow close decoupling between $V_{\rm CC}$ and ground at the package. Both GND₁ and GND₂ should be tied to the ground bus external to the device package.

BLOCK DIAGRAM





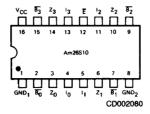
BD001760

RELATED PRODUCTS

Part No.	Description
26S12 26S12A 2915A 2916A 2917A	Quad Bus Transceiver Quad Bus Transceiver Quad Three-State Bus Transceiver with Interface Logic Quad Three-State Bus Transceiver with Interface Logic Quad Three-State Bus Transceiver with Interface Logic

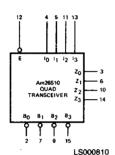
04598A

CONNECTION DIAGRAM Top View



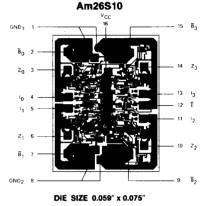
Note: Pin 1 is marked for orientation

LOGIC SYMBOL



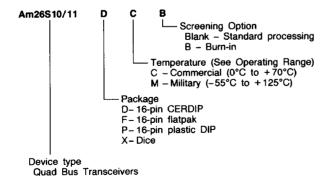
 $V_{CC} = Pin 16$ $GND_1 = Pin 1$ $GND_2 = Pin 8$

METALLIZATION AND PAD LAYOUT



ORDERING INFORMATION

AMD products are available in several packages and operating ranges. The order number is formed by a combination of the following: Device number, speed option (if applicable), package type, operating range and screening option (if desired).



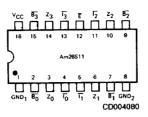
Valid Combinations				
Am26S10 Am26S11	PC DC, DM FM XC, XM			

Valid Combinations

Consult the AMD sales office in your area to determine if a device is currently available in the combination you wish.

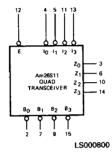
1 ()

CONNECTION DIAGRAM Top View



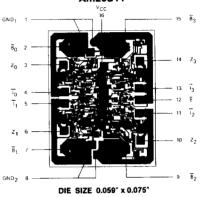
Note: Pin 1 is marked for orientation

LOGIC SYMBOL



 V_{CC} = Pin 16 GND_1 = Pin 1 GND_2 = Pin 8

METALLIZATION AND PAD LAYOUT Am26S11



TRUTH TABLES

Am26S10

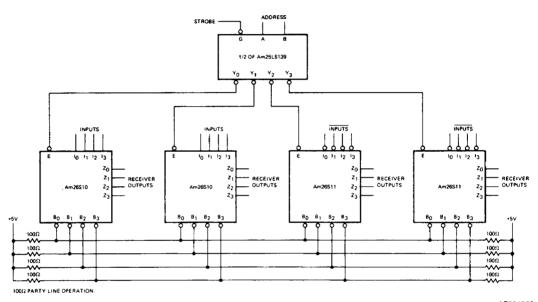
Inputs		Out	puts
Ē	ı	B	Z
L	L	Н	L
L	Н	L	Н
Н	X	Y	Y

Am26S11

Inputs		Outputs		
Ë T		В	Z	
L	L	L	H	
L	н .	Н	L	
Н	Х	Υ	₹	

 $H = HIGH \ Voltage \ Level$ $X = Don't \ Care$ $L = LOW \ Voltage \ Level$ $Y = Voltage \ Level \ of \ Bus \ (Assumes \ Control \ by \ Another \ Bus \ Transceiver)$

TYPICAL APPLICATION



AF001020

ABSOLUTE MAXIMUM RATINGS

Storage Temperature
Supply Voltage to Ground Potential Continuous0.5V to +7.0V
DC Voltage Applied to Outputs For
High Output State0.5V to +V _{CC} max
DC Input Voltage0.5V to +5.5V
DC Output Current, Into Bus200mA
DC Output Current, Into Outputs
(Except Bus)
DC Input Current30mA to +5.0mA

Stresses above those listed under ABSOLUTE MAXIMUM RATINGS may cause permanent device failure. Functionality at or above these limits is not implied. Exposure to absolute maximum ratings for extended periods may affect device reliability.

OPERATING RANGES

Commercial (C) Devi	
Temperature	0°C to +70°C
Supply Voltage	+4.75V to +5.25V
Military (M) Devices	
Temperature	55°C to +125°C
Supply Voltage	+4.5V to +5.5V
Operating ranges det	ine those limits over which the function-
ality of the device is	guaranteed.

DC CHARACTERISTICS over operating range unless otherwise specified

Parameters	Description	Test Conditions (N	Min	Typ (Note 1)	Max	Units	
	O and INCH Voltage	V _{CC} = MIN, I _{OH} = -1.0mA	MIL	2.5	3.4		Volts
V _{OH}	Output HIGH Voltage (Receiver Outputs)	VIN = VIL or VIH	COM'L	2.7	3.4		VOILS
VOL	Output LOW Voltage (Receiver Outputs)	V _{CC} = MIN, I _{OL} = 20mA V _{IN} = V _{IL} or V _{IH}				0.5	Volts
VIH	Input HIGH Level (Except Bus)	Guaranteed input logical HIGH for all inputs					Volts
V _{IL}	Input LOW Level (Except Bus)	Guaranteed input logical LOW for all inputs			0.8	Volts	
Vi	input Clamp Voltage (Except Bus)	V _{CC} = MIN, I _{IN} = -18mA		·		-1.2	Volts
	In and I Old Current		Enable			-0.36	mA
I _{IL}	Input LOW Current (Except Bus)	V _{CC} = MAX, V _{IN} = 0.4V	Data			-0.54	
	<u> </u>		Enable			20] ,
Чн	Input HIGH Current (Except Bus)	V _{CC} = MAX, V _{IN} = 2.7V	Data			30	μΑ
lı	Input HIGH Current (Except Bus)	V _{CC} = MAX, V _{IN} = 5.5V				100	μΑ
	 		MIL	-20		+55	
Isc	Output Short Circuit Current (Except Bus)	V _{CC} = MAX (Note 3)	COM'L	-18		-60	mA
	S. S. Sambu Current	V _{CC} = MAX	Am26S10		45	70	- mA
ICCL	Power Supply Current (All Bus Outputs LOW)	Enable = GND	Am26S11			80	l IIIA

Notes: 1. Typical limits are at V_{CC} = 5.0V, 25°C ambient and maximum loading.

For conditions shown as MIN or MAX, use the appropriate value specified under Electrical Characteristics for the applicable device type.

^{3.} Not more than one output should be shorted at a time. Duration of the short circuit test should not exceed one second.

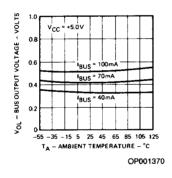
Bus Input/Output Characteristics

Parameters	Description	cription Test Conditions (Note 2)			Min	Typ (Note 1)	Max	Units		
				I _{OL} = 40mA		0.33	0.5			
			MIL	I _{OL} = 70mA		0.42	0.7			
M	Output LOW Voltage	V _{CC} = MIN		I _{OL} = 100mA		0.51	0.8	Volts		
VOL	Output LOW Voltage	VCC - WIII1	COM'L	I _{OL} = 40mA		0.33	0.5			
				I _{OL} = 70mA		0.42	0.7			
i				I _{OL} = 100mA		0.51	0.8			
lo Bu	Bus Leakage Current			V _O = 0.8V			-50	μΑ		
		V _{CC} = MAX	MIL	V _O = 4.5V			200			
			COM'L	V _O = 4.5V	1		100			
lOFF	Bus Leakage Current (Power Off)	V _O = 4.5V		•			100	μΑ		
		Bus Enable = 2	2.41/	MIL	2.4	2.0				
V _{TH}	Receiver Input HIGH Threshold	V _{CC} = MAX		COM'L	2.25	2.0		Volts		
		Bus Enable = 2.4V VCC = MIN		Pur Enghlo = 2.4V	D AV	MIL		2.0	1.6	
V TL			±. → ¥	COM'L		2.0	1.75	Volts		

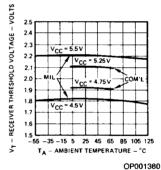
- Notes: 1. Typical limits are at V_{CC} = 5.0V, 25°C ambient and maximum loading.
 2. For conditions shown as MIN or MAX, use the appropriate value specified under Electrical Characteristics for the applicable device type.
 - 3. Not more than one output should be shorted at a time. Duration of the short circuit test should not exceed one second.

TYPICAL PERFORMANCE CURVES

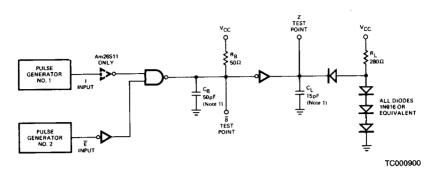
Typical Bus Output Low Voltage Versus Ambient Temperature



Receiver Threshold Variation Versus Ambient Temperature



SWITCHING TEST CIRCUIT



Note 1. Includes Probe and Jig Capacitance.

SWITCHING CHARACTERISTICS (T_A = +25°C, V_{CC} = 5.0V)

Parameters Des		tion	Test conditions	Min	Тур	Max	Units
					10	15	
tpuH	-{	Am26S10			10	15	
t _{PHL}	Data Input to Bus				12	19	ns
t _{PLH}	4	Am26S11	D - 50 O		12	19	ns
tpHL			$R_B = 50 \Omega$ $C_B = 50 pF \text{ (Note 1)}$	—	14	18	
tPLH	_	Am26S10		-	13	18	
^t PHL	Enable input to Bus						
tPLH	T Eriable input to bus				15	20	
tpHL		Am26S11			14	20	ļ
tpLH			$R_B = 50 \Omega$. $R_1 = 280 \Omega$	L	10	15	ns
	Bus to Receiver Out		$R_B = 50 \Omega$, $R_L = 280 \Omega$ $C_B = 50 pF$ (Note 1) $C_L = 15 pF$		10	15	''•
t _{PHL}	D		R _B = 50 Ω	4.0	10		ns
t _r	Bus		C _B = 50 pF (Note 1)	2.0	4.0	1	ns
t _f	Bus		-D F: (,				

Note 1. Includes probe and jig capacitance.

WAVEFORMS

